The 4th annual Innovations in Large-Area Electronics Conference (innoLAE 2018) will be held at the Wellcome Genome Campus Conference Centre in Hinxton, Cambridge, UK on 23-24 January 2018. The two-day conference programme highlights the most innovative and exciting aspects of large-area electronics (including printable, flexible or organic electronics) emerging technologies, their manufacture and the development of products incorporating large-area electronics (LAE).

innoLAE 2018 offers plenary and parallel track oral presentations, a poster session, an exhibition with leading companies showcasing their latest products and networking opportunities, including a reception and a conference gala dinner at Downing College, Cambridge, UK.

Now in its fourth year, innoLAE has established itself as the key event for the large-area electronics community providing valuable opportunities to share latest research results and discuss new projects and collaborations. innoLAE 2018 represents a unique opportunity to hear the latest developments from academic and industrial teams active in LAE research and technology.

**Dates**
23 - 24 January 2018

**Venue**
Wellcome Genome Campus Conference Centre
Cambridge, CB10 1RQ

**Cost**
- £395 standard rate
- £250 academic rate
- £150 student rate
Previous innoLAE conferences at a glance…

innoLAE has seen delegate and exhibitor numbers growing every year as the conference continues to attract equal and growing interest from industry and academia.

In 2017, over 240 delegates representing 133 different organisations in 13 countries attended the three days of conference events.

Delegate growth

<table>
<thead>
<tr>
<th>Year</th>
<th>Delegate Growth</th>
</tr>
</thead>
<tbody>
<tr>
<td>2015</td>
<td>150</td>
</tr>
<tr>
<td>2016</td>
<td>210</td>
</tr>
<tr>
<td>2017</td>
<td>243</td>
</tr>
</tbody>
</table>

Exhibitor growth

<table>
<thead>
<tr>
<th>Year</th>
<th>Exhibitor Growth</th>
</tr>
</thead>
<tbody>
<tr>
<td>2015</td>
<td>9</td>
</tr>
<tr>
<td>2016</td>
<td>16</td>
</tr>
<tr>
<td>2017</td>
<td>25</td>
</tr>
</tbody>
</table>

Institutions represented

<table>
<thead>
<tr>
<th>Year</th>
<th>Institutions Represented</th>
</tr>
</thead>
<tbody>
<tr>
<td>2015</td>
<td>73</td>
</tr>
<tr>
<td>2016</td>
<td>87</td>
</tr>
<tr>
<td>2017</td>
<td>133</td>
</tr>
</tbody>
</table>

innoLAE 2017 delegate mix

- Academic: 44%
- Industry: 45%
- RTO: 7%
- Government: 3%
- Press: 1%
“Excellent conference - it has established a significant position in the UK Large Area Electronics sector.”
- 2016 delegate

“Our company exhibited for 3rd year at innoLAE and each year we find new collaborators and partners and I learn something I learn something new, which is great.”
- 2017 exhibitor

“I think the mix of speakers and exhibitors is great - it really supports the principles of innovation.”
- 2017 delegate

“The conference showed clear evidence of fascinating advances in the field and the roadmap from ‘blue sky’ and lab research to the all-important route to manufacturing and the supply chain.”
- 2017 delegate

“Institutions represented
- innoLAE 2015: 73
- innoLAE 2016: 87
- innoLAE 2017: 133

InnoLAE Industry Day

The 2017 innoLAE industry Day was held the day before the main innoLAE conference to provide an opportunity for UK companies active in large-area electronics to network and discuss the formation of a new UK industry body for the sector.

90 delegates from 65 organisations attended the event, which brought together the UK’s leaders in research, technology innovation and manufacturing of printed, flexible and large-area electronics.

Delegate feedback on the event was very positive with over 95% agreeing that their attendance was worthwhile and the networking opportunity was judged the most useful aspect of the day.
What to expect from innoLAE 2018

The innoLAE 2018 programme will feature 8 sessions

### Conference Structure

#### Day One: 23 January 2018

<table>
<thead>
<tr>
<th>Registration, tea/coffee</th>
</tr>
</thead>
<tbody>
<tr>
<td>Welcome and introduction to the conference and exhibition – Dr Luigi Occhipinti</td>
</tr>
<tr>
<td>EPSRC Centre for Innovative Manufacturing in Large-Area Electronics – Chris Rider</td>
</tr>
<tr>
<td><strong>Keynote 1:</strong> Professor John Rogers, Northwestern University</td>
</tr>
<tr>
<td><strong>Break</strong></td>
</tr>
<tr>
<td><strong>Session 1:</strong> Manufacturing 1: New approaches for LAE manufacturing</td>
</tr>
<tr>
<td><strong>Session 2:</strong> IoT &amp; Sensor Technologies</td>
</tr>
<tr>
<td><strong>Lunch</strong></td>
</tr>
<tr>
<td><strong>Session 3:</strong> Emerging Materials and Technologies</td>
</tr>
<tr>
<td><strong>Session 4:</strong> Wearable and Flexible Hybrid Electronics</td>
</tr>
<tr>
<td>Poster Session and drinks reception</td>
</tr>
<tr>
<td>Poster Prize Presentation</td>
</tr>
<tr>
<td>Gala Dinner at Downing College</td>
</tr>
</tbody>
</table>

#### Day Two: 24 January 2018

| Introduction to the conference (day2) – Chris Rider |
| **Plenary:** Dr John Cocker, Centre for Process Innovation (CPI) |
| **Keynote 2:** Dr Davor Sutija, Thin Film Electronics ASA |
| **Break** |
| **Session 5:** Energy Harvesting |
| **Session 6:** Manufacturing 2: Rheology, metrology and QC |
| **Lunch** |
| **Session 7:** Manufacturing 3 - integration challenges |
| **Workshop on Bioelectronics/biosensors** |
| Concluding remarks (Dr Luigi Occhipinti) |
| Close |
Keynote speakers

We are particularly grateful to our keynotes Professor John Rogers and Dr. Davor Sutija, and to our invited speakers that will help make this event unique by sharing their vision and introducing their latest results at our conference.

Professor John Rogers
Northwestern University

Professor Rogers is internationally renowned for designing and developing electronic devices that can bend, stretch, twist and be integrated with the human body. His research has the potential to change the fields of industrial, consumer and biocompatible electronics.

He is Louis Simpson and Kimberly Querrey Professor of Materials Science and Engineering, Biomedical Engineering and Medicine at Northwestern University and Director of the Center for Bio-Integrated Electronics. He has published nearly 600 papers and invented over 80 patents and patent applications, more than 50 of which are licensed or in active use by large companies and startups that he has co-founded, including Active Impulse Systems, Semprius, MC10, CoolEdge, XCeleprint and Transient Electronics.

Dr. Davor Sutija
Thin Film Electronics ASA

Dr. Davor Sutija is CEO of Thin Film Electronics ASA. Prior to joining ThinFilm in January 2010, he was Senior Vice President, Product Marketing, at FAST (a Microsoft subsidiary) and founding CEO at SiNOR AS, a producer of electronic and PV-grade silicon ingots.

Dr. Sutija is a highly sought-after speaker and presents around the globe on topics including the Internet of Things, the convergence of the physical and digital worlds, and the future of smart packaging. He was a keynote speaker at Mobile World Congress 2015. Dr. Sutija graduated from the Jerome Fisher Management and Technology program at the Wharton School, and has a Ph.D. from the University of California, Berkeley, in Chemical Engineering. He was a Hertz Fellow at Lawrence Berkeley Labs.

For further details you can read their full biographies on innoLAE.org
Confirmed invited speakers currently include...

**INVITED SPEAKERS**

- Professor Steve Beeby, *University of Southampton*
- Professor Tim Claypole, *Swansea University*
- Dr Claudia Delgado Simao, *Eurecat*
- Dr Guangbin Dou, *Imperial College London*
- Professor Andrea Ferrari, *University of Cambridge*
- Professor Elvira Fortunato, *New University of Lisob/CEN-IMAT*
- Miguel Carrasco, *Cambridge Display Technology Ltd*
- Jaap Lombaers, *Holst Centre*
- Professor George Malliaras, *University of Cambridge*
- Dr Simon Ogier, *NeuDrive*
- Dr Paul Smith, *Xerox*
- Professor Luisa Torsi, *University of Bari*
- Dr Iain Williams, *Department for Environment, Food and Rural Affairs*
- Mathieu Bellanger, *Lightricity Ltd*
- João Manuel Carvalho Gomes, *CeNTI*
- Dr Feras Alkhalil, *PragmatIC*
- Dr Francesca Bottacchi, *FlexEnable*
- Professor Ravinder Dahiya, *University of Glasgow*
- Mansoor D’Lavari, *Merck*
- Dr Davide Deganello, *Swansea University*
- Dr Guangbin Dou, *Imperial College London*
- Dr Chris Evans, *Peratech Holdco Ltd*
- Alexandre Gaïtis, *LITEN*
- Suresh Garlapati, *University of Manchester*
- Dr Dimitra Georgiadou, *Imperial College London*
- Dr Adam Graham, *Centre for Process Innovation*
- Dr John Hardy, *Lancaster University*
- Chen Jiang, *University of Cambridge*
- Dr Woo Soo Kim, *Simon Fraser University*
- Dr Thomas Kolbusch, *Coatema Coating Machinery GmbH*
- Professor Yu Liu, *Jiangnan University*
- Dr Iyad Nasrallah, *University of Cambridge*
- Dr Daniel O’Connor, *National Physical Laboratory*
- Iain Sedgwick, *Rutherford Appleton Laboratory*
- Dr Simon Tuohy, *Oxford Lasers*
- Dr Wenzhuo Wu, *Purdue University*
- Dr Bin Yang, *University of Chester*
Who should attend?

- Researchers
- Business Development professionals
- End-users
- Process developers
- Manufacturing engineers
- Technology scouts

Why should you attend?

- **Gain** access to key decision-makers in the UK LAE community
- **Hear** the latest results from UK academics
- **Learn** from representatives of global companies active in the technology
- **Form** new partnerships with delegates, vendors and speakers
- **Network** with colleagues at the gala dinner and the drinks reception

Sectors

- Electronics and displays
- Sensors and devices
- Energy
- Printing and packaging
- Healthcare and biomedical
- Automotive
- Aerospace and defence
To discuss exhibiting at innoLAE 2018, please contact Dr Luigi Occhipinti.
E: luigi.occhipinti@eng.cam.ac.uk   T: +44(0)1223 332838
Why exhibit?

• Highlight your company’s expertise to a highly targeted audience
• Raise brand awareness and recognition via logo and advertisement placement
• Leverage your exhibition through marketing campaigns and social media
• Generate leads and form new partnerships with delegates, vendors and speakers
• Demonstrate your products or services
• Find new talent for your organisation

Cost

£800 (+VAT) - includes one delegate registration and a standard table top with power.
<table>
<thead>
<tr>
<th>Package Benefits</th>
<th>Platinum £5,000 (+ VAT)</th>
<th>Gold £3,000 (+ VAT)</th>
<th>Silver £1,850 (+VAT)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Free attendance for company representatives including gala dinner</td>
<td>5 spaces</td>
<td>3 spaces</td>
<td>2 spaces</td>
</tr>
<tr>
<td>Exhibition stand (table top)</td>
<td>Double stand</td>
<td>Standard table top</td>
<td>Standard table top</td>
</tr>
<tr>
<td>Logo on the conference website and all printed materials (event flyer, programme folder, etc.)</td>
<td>✓</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>One speaker/presentation slot</td>
<td>✓</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>Logo on welcome screen during the conference</td>
<td>✓</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>Poster prize presentation at the poster session &amp; promotion of company as poster prize sponsor</td>
<td>✓</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>Opportunity to distribute company brochures in delegates’ bags</td>
<td>✓</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>Logo printed on delegates’ badges</td>
<td>✓</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>Acknowledgement of sponsorship at the conference gala dinner</td>
<td>✓</td>
<td>✓</td>
<td>✓</td>
</tr>
<tr>
<td>Company logo printed on welcome banner in the registration area</td>
<td>✓</td>
<td>✓</td>
<td>✓</td>
</tr>
</tbody>
</table>

To discuss these or bespoke sponsorship options, please contact Dr Luigi Occhipinti. E: luigi.occhipinti@eng.cam.ac.uk T: +44(0)1223 332838
# Additional sponsorship opportunities

<table>
<thead>
<tr>
<th>Lanyard sponsor</th>
<th>£750 (+VAT)</th>
<th>Delegate bag sponsor</th>
<th>£1,000 (+VAT)</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Sponsorship benefits</strong></td>
<td></td>
<td><strong>Sponsorship benefits</strong></td>
<td></td>
</tr>
<tr>
<td>✓ Sponsor logo on all nametag lanyards, which will be distributed during registration to every delegate</td>
<td>✓ Sponsor’s logo printed on the conference bag, alongside the conference logo. The bags will be distributed to all delegates during registration</td>
<td>✓ Sustained branding through bag re-useage post event</td>
<td></td>
</tr>
<tr>
<td>✓ Listing as a conference sponsor both digitally and in print communications (conference website, event flyer, programme brochure, etc.)</td>
<td>✓ Listing as a conference sponsor both digitally and in print communications (conference website, event flyer, programme brochure, etc.)</td>
<td>✓ Logo on welcome screen during the conference</td>
<td>✓ Logo on welcome screen during the conference</td>
</tr>
<tr>
<td>✓ Logo on welcome screen during the conference</td>
<td>✓ Any extra lanyards will be given to the sponsor at the end of the conference. <strong>The sponsor will provide a high-resolution (.eps) logo to the innoLAETEAM who will design and purchase the lanyards.</strong></td>
<td>✓ The sponsor will provide a high-resolution (.eps) logo to the innoLAETEAM who will design and purchase the bags.</td>
<td></td>
</tr>
</tbody>
</table>

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To discuss these or bespoke sponsorship options, please contact Dr Luigi Occhipinti.  
E: luigi.occhipinti@eng.cam.ac.uk    T: +44(0)1223 332838
Please feel free to get in touch.

Email us at: info@largeareaelectronics.org

Visit our website: www.innoLAE.org

Follow us at: @EPSRCCentreLAE @innoLAE